

Schottky Barrier Diode Silicon Epitaxial

# DSF01S30SL

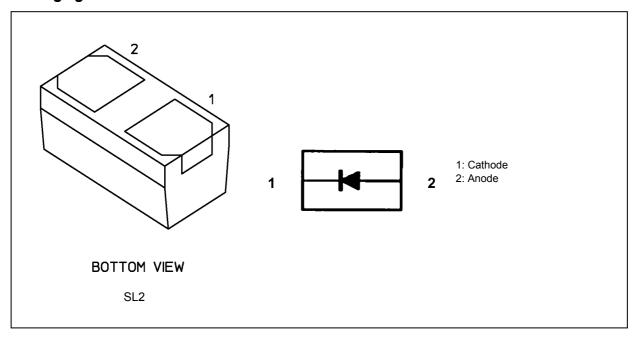
#### 1. Applications

· High-Speed Switching

#### 2. Features

(1) Low forward voltage:  $V_F = 0.41 \text{ V (typ.)} @ I_F = 100 \text{ mA}$ 

#### 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Reverse voltage	V <sub>R</sub>		30	V
Peak forward current	I <sub>FM</sub>		200	mA
Average rectified current	Io	(Note 1)	100	
Non-repetitive peak forward surge current	I <sub>FSM</sub>	(Note 2)	2	Α
Junction temperature	Tj		125	°C
Storage temperature	T <sub>stg</sub>	·	-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Pad dimension of 645 mm<sup>2</sup>.

Note 2: Measured with a 10 ms pulse.

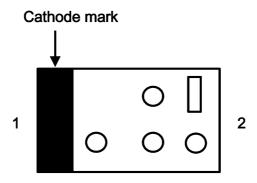
Start of commercial production



## 5. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	_	0.27	0.3	V
			I <sub>F</sub> = 100 mA	_	0.41	0.5	
Reverse current	I <sub>R</sub>		V <sub>R</sub> = 10 V	_	_	7	μА
			V <sub>R</sub> = 30 V	_	_	50	
Total capacitance	Ct		V <sub>R</sub> = 0 V, f = 1 MHz	_	9.3		pF

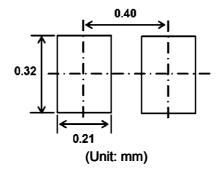
## 6. Marking



#### 7. Usage Considerations

Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs
more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both
forward and reverse power losses of SBDs should be considered for thermal and safety design.

#### 8. Land Pattern Dimensions (for reference only)



## 9. Characteristics Curves (Note)

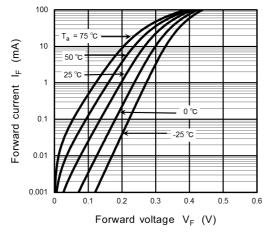


Fig. 9.1 I<sub>F</sub> - V<sub>F</sub>

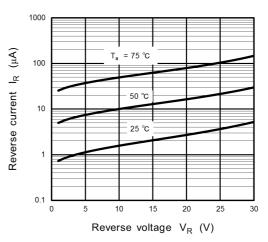
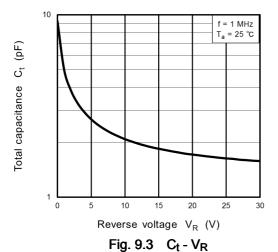


Fig. 9.2 I<sub>R</sub> - V<sub>R</sub>

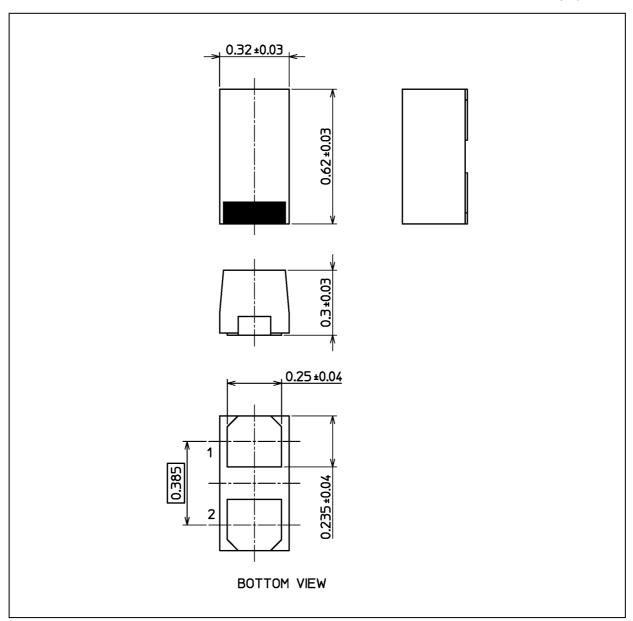


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 0.2 mg (typ.)

	Package Name(s)
TOSHIBA: 1-1AL1A	
Nickname: SL2	



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2015-06-11

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